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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of

Yeo et al.

Serial No.: 10/078,719

Filed: February 19, 2002

For: **ENHANCED CHIP SCALE PACKAGE
FOR FLIP CHIPS**

Attorney's Docket No. 4795-001

Examiner
Group Art Unit 2833

Raleigh, North Carolina

May 1, 2002

Commissioner for Patents
Washington, D.C. 20231

Dear Sir:

The above-identified application claims priority based on Singapore Application No. 200106785-9. Enclosed please find a certified copy of Singapore Application No. 200106785-9. We filed the above-identified U.S. application without the certified copy.

Respectfully submitted,

COATS & BENNETT, P.L.L.C.

By:

[Signature]
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